

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT6079053

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUSUKE OTAKE	03/29/2018
AKIRA MATSUMOTO	03/29/2018
JUNPEI YAMAMOTO	03/29/2018
RYUSEI NAITO	04/12/2018
MASAHICO NAKAMIZO	03/29/2018
TOSHIFUMI WAKANO	03/29/2018
RECEIVING PARTY DATA	
Name:	SONY SEMICONDUCTOR SOLUTIONS CORPORATION
Street Address:	4-14-1 ASAHI-CHO
Internal Address:	ATSUGI-SHI
City:	KANAGAWA
State/Country:	JAPAN
Postal Code:	243-0014
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16694195
CORRESPONDENCE DATA	
Fax Number:	(303)863-0223
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	303-863-9700
Email:	sony@sheridanross.com
Correspondent Name:	SHERIDAN ROSS P.C.
Address Line 1:	1560 BROADWAY
Address Line 2:	SUITE 1200
Address Line 4:	DENVER, COLORADO 80202-5141
ATTORNEY DOCKET NUMBER:	6810-950-CON-2 (KRC)
NAME OF SUBMITTER:	KRISTEN R. COKAS
SIGNATURE:	/Kristen R. Cokas/
DATE SIGNED:	04/27/2020

PATENT

Total Attachments: 6

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**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN
APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE**

Title of
Invention

PHOTODETECTOR

As the below named inventor, I hereby declare that:

This declaration
is directed to:

☐

The attached application, or

☒

United States application or PCT international application number PCT/JP2017/037748
filed on 2017/10/18.

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, SONY SEMICONDUCTOR SOLUTIONS CORPORATION, with offices at
4-14-1 Asahi-cho, Atsugi-shi, Kanagawa, Japan (hereinafter referred to as ASSIGNEE), is desirous of
acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar
legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency
of which are hereby acknowledged, I by these presents do hereby assign, sell and transfer unto said ASSIGNEE, its successors, assigns, and
legal representatives, the entire right, title and interest in said invention, said application, including any divisions and continuations thereof, and
in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to
any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American
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adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the
United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue said United States Letters
Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its
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And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said
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And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with
this assignment and sale.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of
not more than five (5) years, or both.

LEGAL NAME OF INVENTOR

Inventor: YUSUKE OTAKE

Date: March 29, 2018

Signature: Yusuke Otake

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LEGAL NAME OF INVENTOR

Inventor: AKIRA MATSUMOTO

Date: March 29, 2018

Signature: Akira Matsumoto

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LEGAL NAME OF INVENTOR

Inventor: JUNPEI YAMAMOTO

Date: March 29, 2018

Signature:

Junpei Yamamoto

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LEGAL NAME OF INVENTOR

Inventor: ryusei naito

Date: 2018/4/12

Signature: ryusei naito

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LEGAL NAME OF INVENTOR

Inventor: MASAHIKO NAKAMIZO

Date: March 29, 2018

Signature:

Masahiko Nakamizo

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Signature:

Toshifumi Wakano